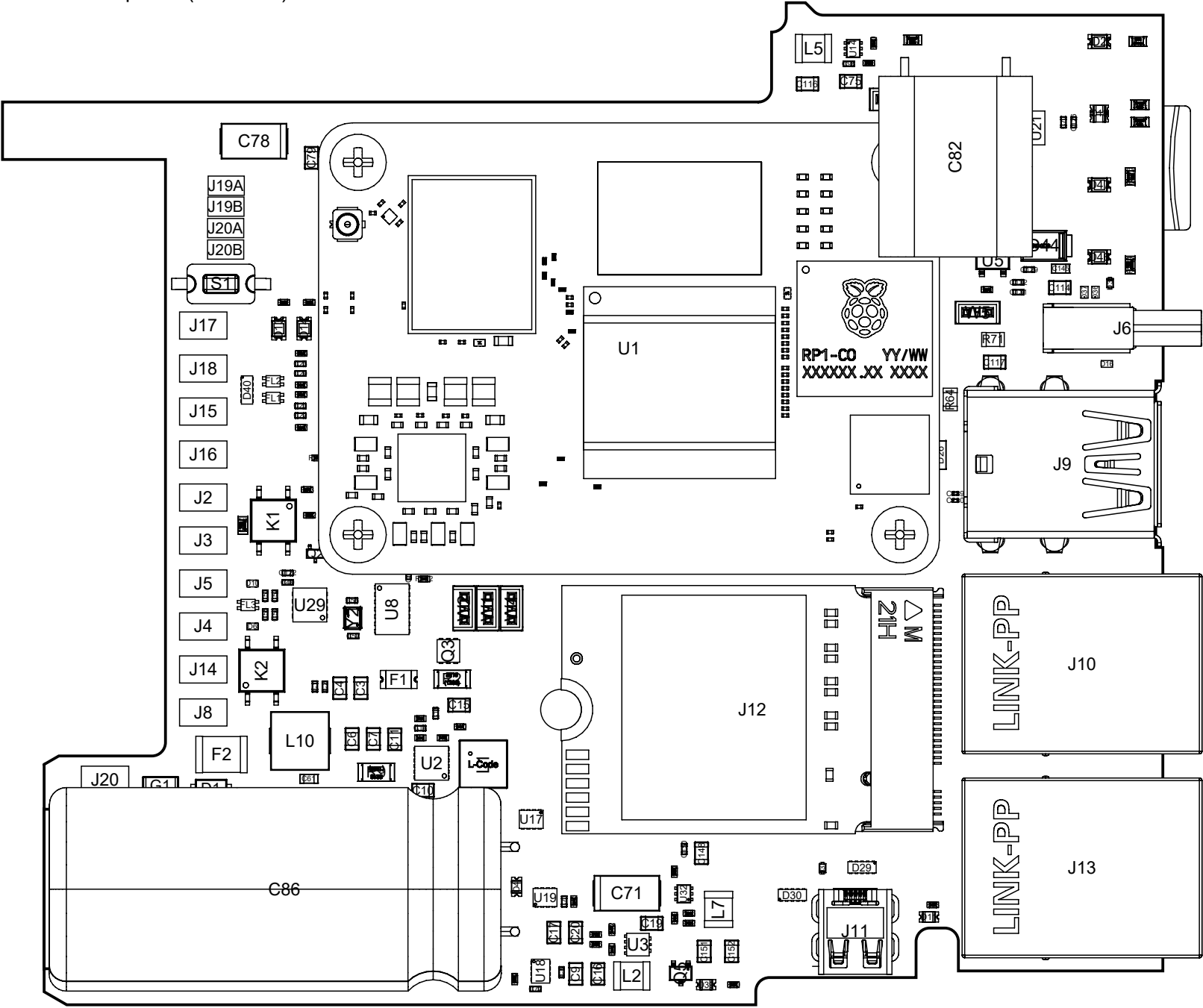
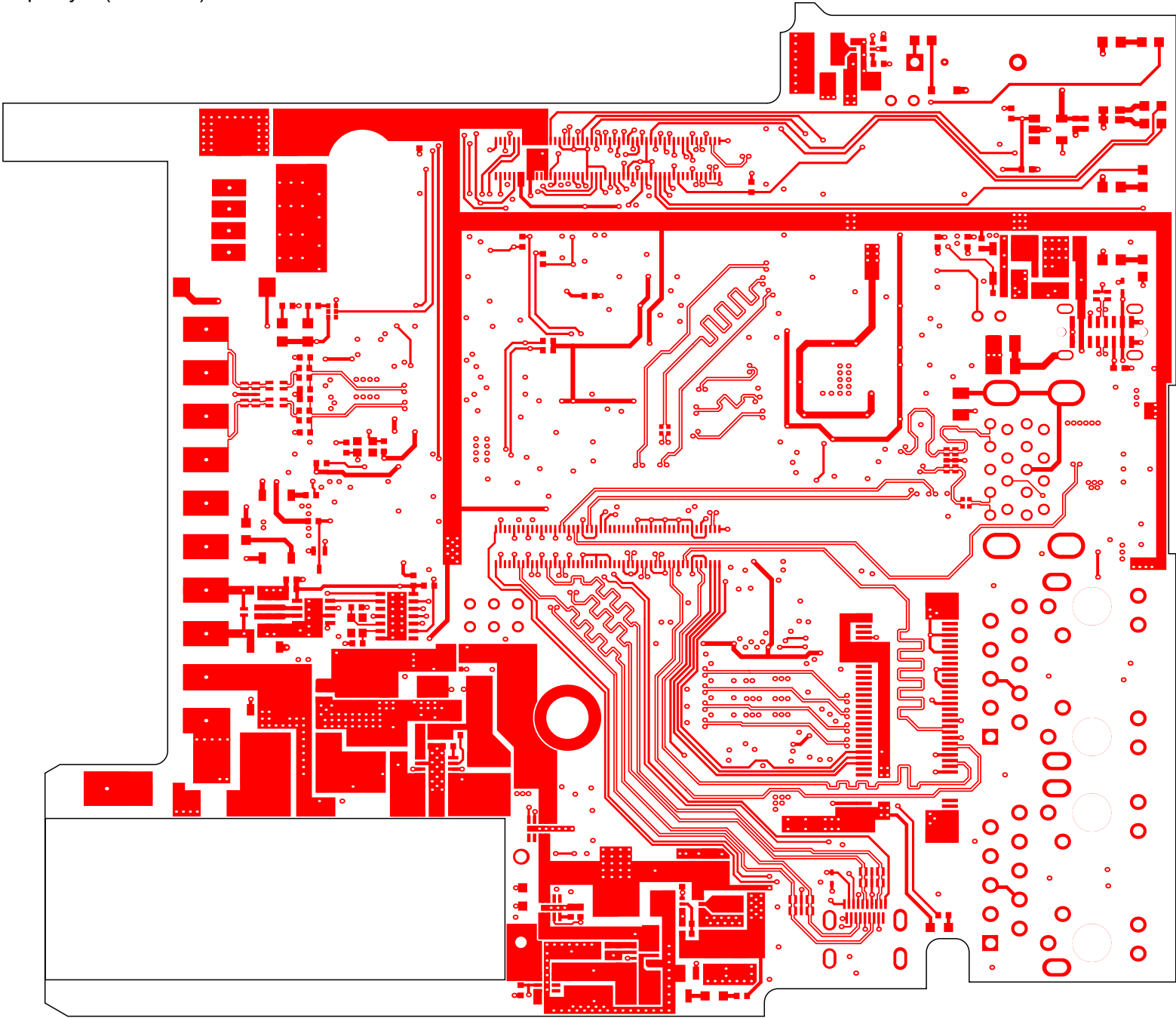


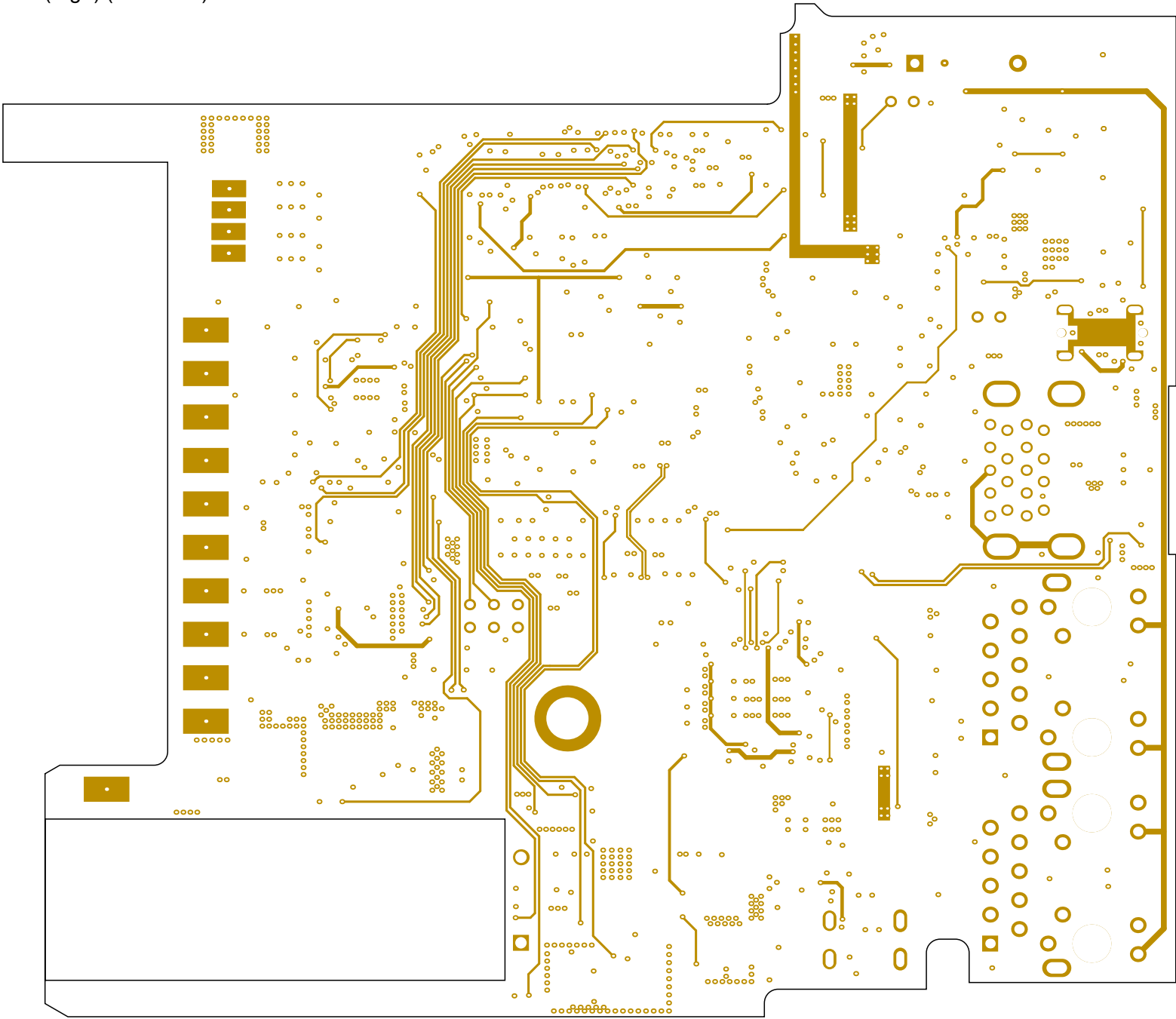
View from Top side (Scale 2:1)



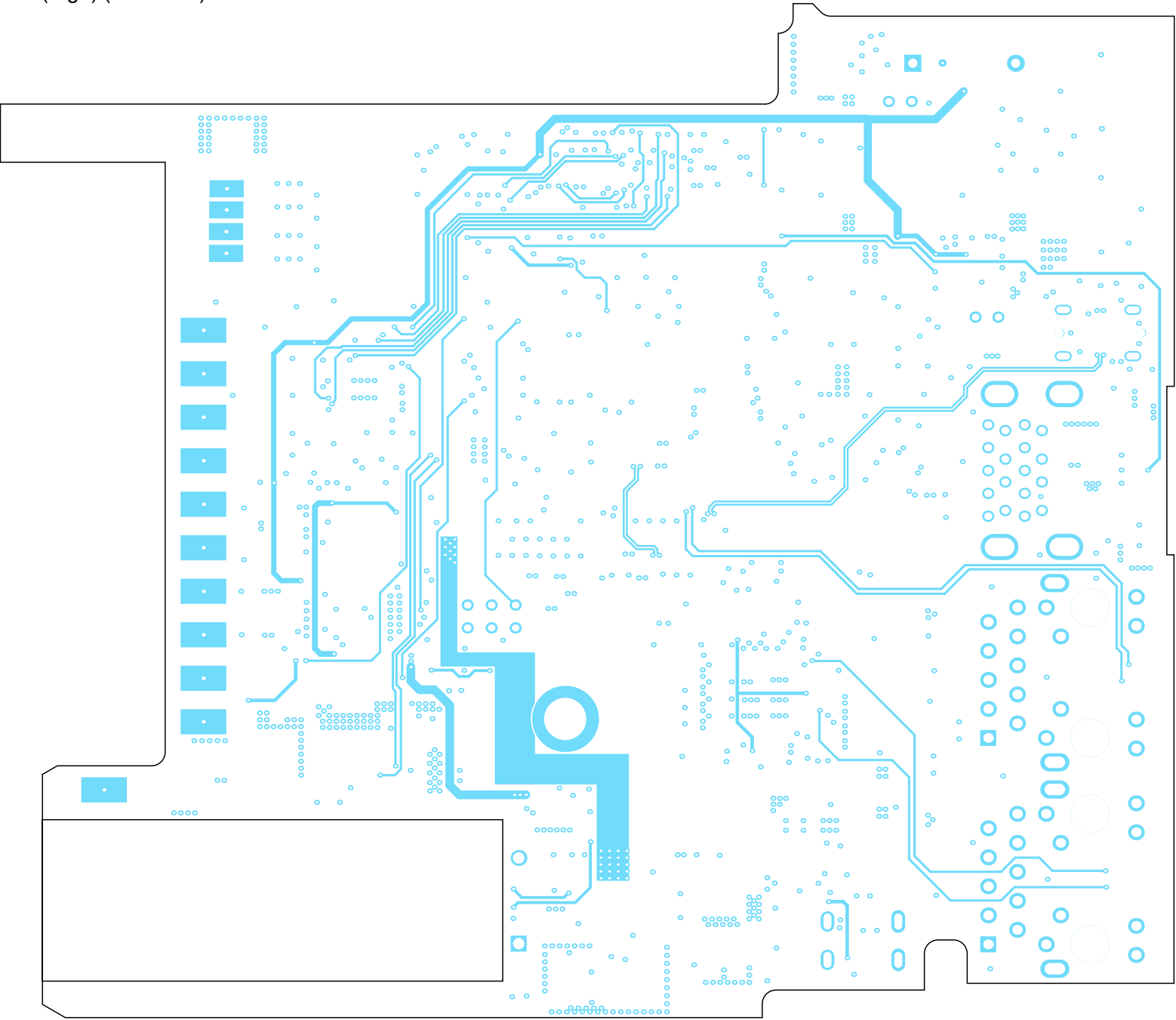
Top Layer (Scale 2:1)



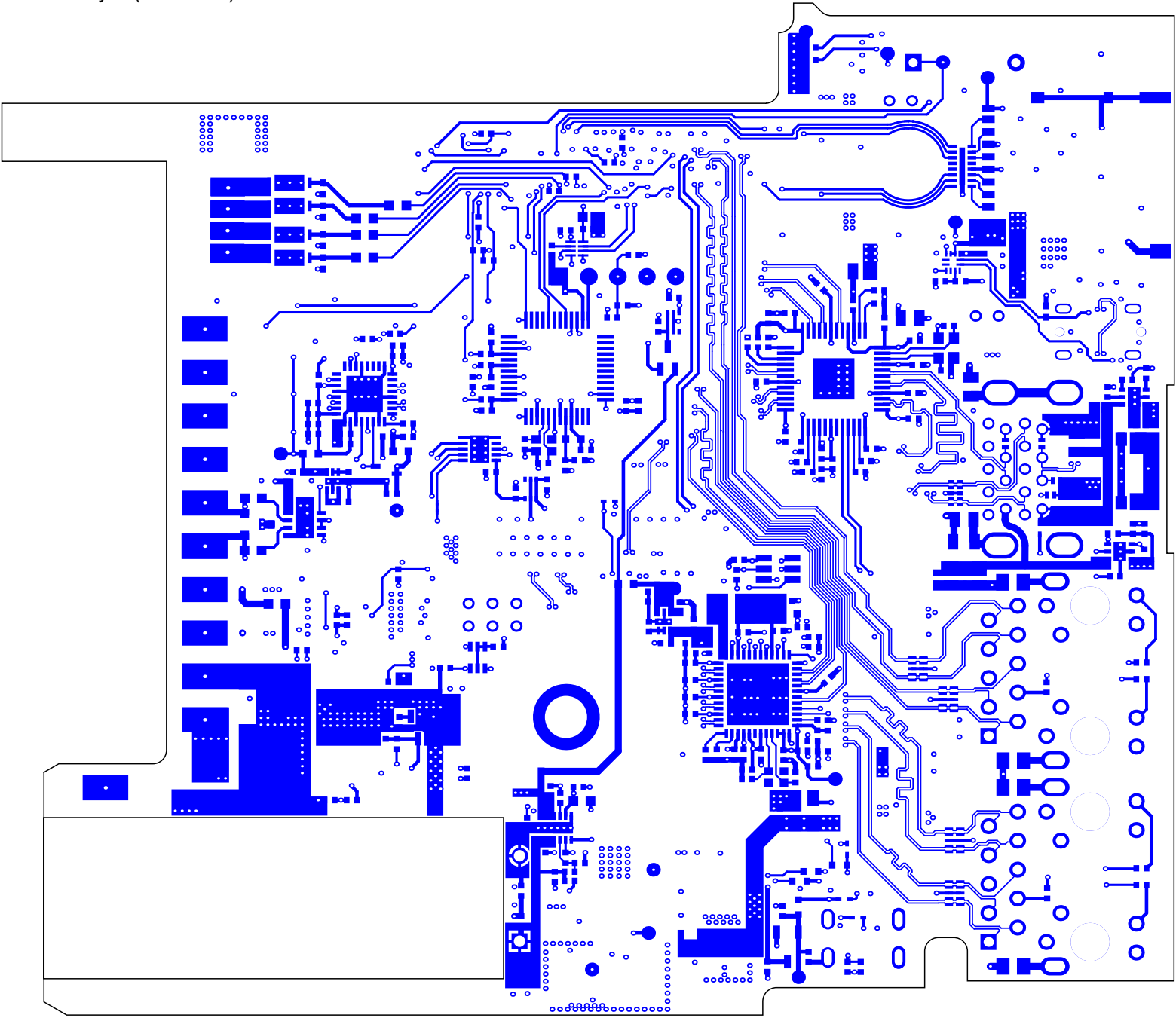
Int2 (Sign) (Scale 2:1)



Int3 (Sign) (Scale 2:1)



Bottom Layer (Scale 2:1)



Layer Stack Legend

Material	Layer	Thickness	Dielectric Material	Material Type	Gerber
	Top Overlay			Legend	GTO
	Surface Material	0.03mm	SM-001	Solder Mask	GTS
PbSn	Top Surface Finish	0.02mm		Surface Finish	
CF-004	Top Layer	0.04mm		Signal	GTL
Prepreg		0.09mm	PP-006	Dielectric	
CF-004	Int1 (GND)	0.03mm		Internal Plane	GP1
Core		0.30mm	Core-035	Dielectric	
CF-004	Int2 (Sign)	0.03mm		Signal	G1
Prepreg		0.20mm	PP-006	Dielectric	
Prepreg		0.22mm	PP-006	Dielectric	
Prepreg		0.20mm	PP-006	Dielectric	
CF-004	Int3 (Sign)	0.03mm		Signal	G2
Core		0.30mm	Core-035	Dielectric	
CF-004	Int4 (PWR)	0.03mm		Internal Plane	GP2
Prepreg		0.09mm	PP-006	Dielectric	
CF-004	Bottom Layer	0.04mm		Signal	GBL
PbSn	Bottom Surface Finish	0.02mm		Surface Finish	
Surface Material	Bottom Solder	0.03mm	SM-001	Solder Mask	GBS
	Bottom Overlay			Legend	GBO
Total thickness: 1.69mm					

Drill Table

Symbol	Count	Hole Size	Plated	Hole Tolerance
F	1064	0.20mm(8mil)	Plated	
▽	15	0.30mm(12mil)	Plated	
◇	14	0.60mm(24mil)	Plated	
⊕	18	0.65mm(26mil)	Plated	
⊗	4	0.70mm(28mil)	Plated	
K	2	0.80mm(31mil)	Non-Plated	
□	2	0.80mm(31mil)	Plated	
⊗	36	0.85mm(33mil)	Plated	
□	6	1.00mm(39mil)	Plated	
⊗	1	1.10mm(43mil)	Non-Plated	
⊕	1	1.10mm(43mil)	Plated	
▽	1	1.15mm(45mil)	Non-Plated	
c	4	1.60mm(63mil)	Plated	
○	1	1.65mm(65mil)	Non-Plated	
A	4	2.70mm(106mil)	Plated	
◎	4	3.35mm(132mil)	Non-Plated	
☆	1	3.70mm(146mil)	Plated	
	1178 Total			

